

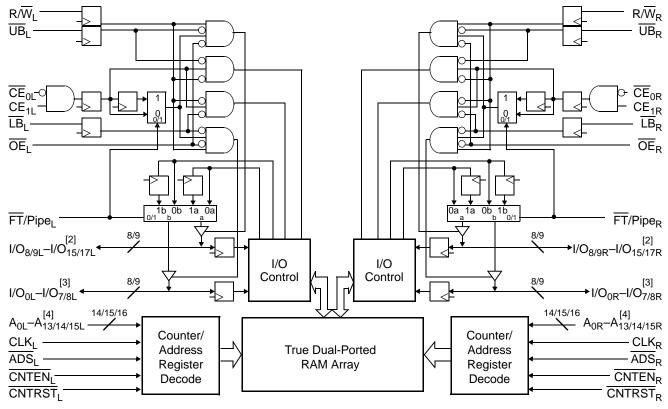
CY7C09269V/79V/89V CY7C09369V/89V

<u>3.3 V 16 K / 32 K / 64 K × 16 / 18</u> Synchronous Dual-Port Static RAM

Features

- True dual-ported memory cells that allow simultaneous access of the same memory location
- Six flow through/pipelined devices: I 16 K × 16 / 18 organization (CY7C09269V/369V) □ 32 K × 16 organization (CY7C09279V) G4 K × 16 / 18 organization (CY7C09289V/389V)
- Three modes:
 - □ Flow through
 - Pipelined
 - Burst
- Pipelined output mode on both ports allows fast 100 MHz operation
- 0.35 micron CMOS for optimum speed and power

- High speed clock to data access: 7.5^[1], 9, 12 ns (max)
- 3.3 V low operating power: Active = 115 mA (typical)
- \Box Standby = 10 μ A (typical)
- Fully synchronous interface for easier operation
- Burst counters increment addresses internally:
 - Shorten cycle times
 - Minimize bus noise
- Supported in flow through and pipelined modes
- Dual chip enables easy depth expansion
- Upper and lower byte controls for bus matching
- Automatic power down
- Commercial and industrial temperature ranges
- Pb-free 100-pin TQFP package available



Logic Block Diagram

Notes

- 1. See Figure 4 on page 8 for Load Conditions.

- 1. See Figure 4 on page 8 for Load Conditions. 2. $I/O_8-I/O_{15}$ for x 16 devices; $I/O_9-I/O_{17}$ for x 18 devices. 3. $I/O_0-I/O_7$ for x 16 devices. $I/O_0-I/O_8$ for x 18 devices. 4. A_0-A_{13} for 16K; A_0-A_{14} for 32K; A_0-A_{15} for 64K devices.

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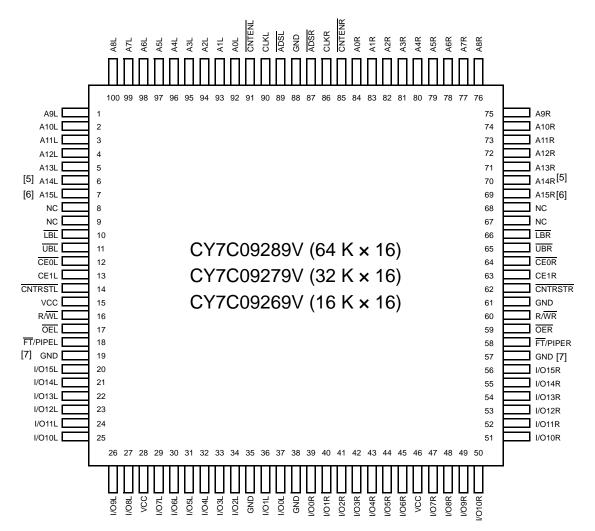
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Pin Configurations

Figure 1. 100-pin TQFP (Top View)

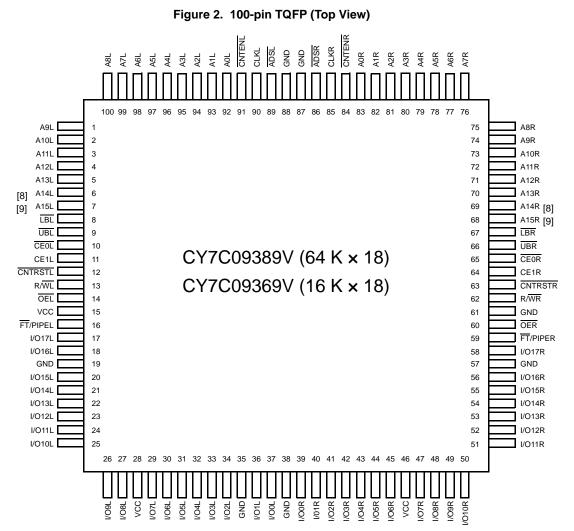


Notes

- 5. This pin is NC for CY7C09269V.
- 6. This pin is NC for CY7C09269V and CY7C09279V.
- 7. For CY7C09269V and CY7C09279V, pin #18 connected to V_{CC} is pin compatible to an IDT 5 V x 16 pipelined device; connecting pin #18 and #58 to GND is pin compatible to an IDT 5 V x 16 flow through device.



Pin Configurations (continued)



Notes

8. This pin is NC for CY7C09369V.

9. This pin is NC for CY7C09369V.



Selection Guide

Specifications	CY7C09269V/79V/89V CY7C09369V/89V	CY7C09269V/79V/89V CY7C09369V/89V	CY7C09269V/79V/89V CY7C09369V/89V
	-7 ^[10]	-9	-12
f _{MAX2} (MHz) (Pipelined)	83	67	50
Max. Access Time (ns) (Clock to Data, Pipelined)	7.5	9	12
Typical Operating Current I _{CC} (mA)	155	135	115
Typical Standby Current for I _{SB1} (mA) (Both Ports TTL Level)	25	20	20
Typical Standby Current for $I_{SB3}\left(\mu A\right)$ (Both Ports CMOS Level)	10	10	10

Pin Definitions

Left Port	Right Port	Description
A _{0L} -A _{15L}	A _{0R} -A _{15R}	Address Inputs (A ₀ -A ₁₄ for 32K, A ₀ -A ₁₃ for 16K devices).
ADSL	ADS _R	Address Strobe Input. Used as an address qualifier. This signal must be asserted LOW to access the part using an externally supplied address. Asserting this signal LOW also loads the burst counter with the address present on the address pins.
CE _{0L} , CE _{1L}	CE _{0R} ,CE _{1R}	Chip Enable Input. To select either the left or right port, both \overline{CE}_0 AND CE_1 must be asserted to their active states ($\overline{CE}_0 \le V_{IL}$ and $CE_1 \ge V_{IH}$).
CLKL	CLK _R	Clock Signal. This input can be free running or strobed. Maximum clock input rate is f _{MAX} .
CNTENL	CNTENR	Counter Enable Input. Asserting this signal LOW increments the burst address counter of its respective port on each rising edge of CLK. CNTEN is disabled if ADS or CNTRST are asserted LOW.
CNTRSTL	CNTRSTR	Counter Reset Input. Asserting this signal LOW resets the burst address counter of its respective port to zero. CNTRST is not disabled by asserting ADS or CNTEN.
I/O _{0L} -I/O _{17L}	I/O _{0R} -I/O _{17R}	Data Bus Input/Output (I/O ₀ -I/O ₁₅ for x 16 devices).
LBL	LB _R	Lower Byte Select Input . Asserting this signal LOW enables read and write operations to the lower byte. ($I/O_0-I/O_8$ for x 18, $I/O_0-I/O_7$ for x 16) of the memory array. For read operations both the LB and OE signals must be asserted to drive output data on the lower byte of the data pins.
UBL	UB _R	Upper Byte Select Input. Same function as \overline{LB} , but to the upper byte ($I/O_{8/9L}$ - $I/O_{15/17L}$).
OEL	OE _R	Output Enable Input. This signal must be asserted LOW to enable the I/O data pins during read operations.
R/WL	R/W _R	Read/Write Enable Input . This signal is asserted LOW to write to the dual port memory array. For read operations, assert this pin HIGH.
FT/PIPE _L	FT/PIPE _R	Flow Through/Pipelined Select Input. For flow through mode operation, assert this pin LOW. For pipelined mode operation, assert this pin HIGH.
GND	·	Ground Input.
NC		No Connect.
V _{CC}		Power Input.



Functional Description

The CY7C09269V/79V/89V and CY7C09369V/89V are high speed 3.3 V synchronous CMOS 16 K, 32 K, and 64 K × 16 and 16 K and 64 K × 18 dual-port static RAMs. Two ports are provided, permitting independent, simultaneous access for reads and writes to any location in memory ^[11]. Registers on control, address, and data lines allow for minimal setup and hold times. In pipelined output mode, data is registered for decreased cycle time and clock to data valid $t_{CD2} = 7.5$ ns ^[12] (pipelined). Flow through mode can also be used to bypass the pipelined output register to eliminate access latency. In flow through mode, data is available $t_{CD1} = 18$ ns after the address is clocked into the device. Pipelined output or flow through mode is selected through the FT/Pipe pin.

Each port contains a burst counter on the input address register. The internal write pulse width is independent of the LOW to HIGH transition of the clock signal. The internal write pulse is self timed to allow the shortest possible cycle times. A HIGH on \overline{CE}_0 or LOW on CE_1 for one clock cycle powers down the internal circuitry to reduce the static power consumption. The use of multiple Chip Enables enables easier banking of multiple chips for depth expansion <u>configurations</u>. In the pipelined mode, one cycle is required with \overline{CE}_0 LOW and \overline{CE}_1 HIGH to reactivate the outputs.

Counter enable inputs are provided to stall the operation of the address input and use the internal address generated by the internal counter for fast interleaved memory applications. A <u>port's</u> burst counter is loaded with th<u>e port's</u> Address Strobe (ADS). When the port's Count Enable (CNTEN) is asserted, the address counter increments on each LOW to HIGH transition of that port's clock signal. This reads/writes <u>one word</u> from or into each successive address location, until CNTEN is deasserted. The counter can address th<u>e entire memory</u> array and loop back to the start. Counter Reset (CNTRST) is used to reset the burst counter.

All parts are available in 100-pin Thin Quad Plastic Flatpack (TQFP) packages.

Notes

11. When writing simultaneously to the same location, the final value cannot be guaranteed.

12. See Figure 4 on page 8 for Load Conditions.



Maximum Ratings

Exceeding maximum ratings ^[13] may impair the useful life of the device. These user guidelines are not tested.

Storage Temperature65 °C to +	-150 °C
Ambient Temperature with Power Applied55 °C to +	-125 °C
Supply Voltage to Ground Potential0.5 V to	+4.6 V
DC Voltage Applied to Outputs in High Z State0.5 V to V_{CC}	+ 0.5 V

Electrical Characteristics

Over the Operating Range

DC Input Voltage	–0.5 V to V _{CC} + 0.5 V
Output Current into Outputs (LOW) .	20 mA
Static Discharge Voltage (per MIL-STD-883, Method 3015)	> 1100 V
Latch up Current	> 200 mA

Operating Range

Range	Ambient Temperature	V _{CC}
Commercial	0 ℃ to +70 ℃	$3.3~V~\pm 300~mV$
Industrial	–40 ℃ to +85 ℃	$3.3~V~\pm 300~mV$

Demonster	Description	CY7C09269V/79V/89V CY7C09369V/89V										
Parameter	Description			-7 ^[14]			-9			-12		Unit
			Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	
V _{OH}	Output HIGH Voltage (V_{CC} = Min, I_{OH}	= -4.0 mA)	2.4	-	-	2.4	-	-	2.4	-	-	V
V _{OL}	Output LOW Voltage (V_{CC} = Min, I _{OH}	= +4.0 mA)	_	-	0.4	-	-	0.4	-	-	0.4	V
V _{IH}	Input HIGH Voltage		2.0	_	-	2.0	_	-	2.0	_	-	V
V _{IL}	Input LOW Voltage		_	_	0.8	-	_	0.8	-	_	0.8	V
I _{OZ}	Output Leakage Current	-10	_	10	-10	_	10	-10	_	10	μΑ	
I _{CC}	Operating Current	Commercial	_	155	275	-	135	230	-	115	180	mA
	(V _{CC} = Max, I _{OUT} = 0 mA) Outputs Disabled	Industrial	-	275	390	-	185	300	-	-	-	mA
I _{SB1}	Standby Current	Commercial	-	25	85	-	20	75	-	20	70	mA
	$\frac{(Both Ports TTL Level)}{CE_L \& CE_R \ge V_{IH}, f = f_{MAX}}$	Industrial	-	85	120	-	35	85	-	-	-	mA
I _{SB2}	Standby Current	Commercial	-	105	165	-	95	155	-	85	140	mA
	$\frac{(One Port TTL Level)}{CE_L CE_R \ge V_{IH}, f = f_{MAX}}$	Industrial	-	165	210	Ι	105	165	Ι	-	-	mA
I _{SB3}	Standby Current	Commercial	-	10	250	-	10	250	-	10	250	μΑ
	$\label{eq:both_constraints} \begin{array}{l} \underline{(Both\ Ports\ CMOS\ Level)}\ ^{[15]}\\ \hline CE_L\ \&\ CE_R \geq V_{CC} - 0.2\ V,\ f = 0 \end{array}$	Industrial	-	10	250	Ι	10	250	Ι	-	-	μΑ
I _{SB4}	Standby Current	Commercial	-	95	125	1	85	115	Ι	75	100	mA
	$\label{eq:constraint} \frac{(One \ Port \ CMOS \ Level)^{[15]}}{CE_L \ \ CE_R \ge V_{IH}, \ f = f_{MAX}}$	Industrial	-	125	170	-	95	125	-	-	-	mA

Capacitance

Parameter ^[16]	Description	Test Conditions	Мах	Unit
C _{IN}	Input Capacitance	$T_A = 25 \text{ °C}, f = 1 \text{ MHz}, V_{CC} = 3.3 \text{ V}$	10	pF
C _{OUT}	Output Capacitance		10	pF

Notes

13. The voltage on any input or I/O pin can not exceed the power pin during power up.

14. See Figure 4 on page 8 for Load Conditions.

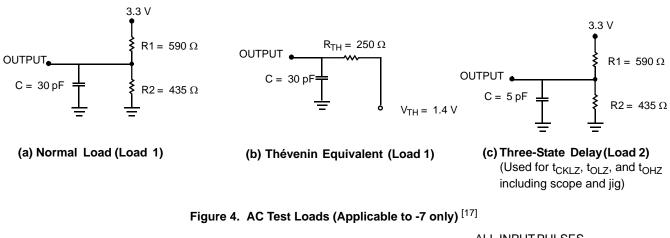
15. \overline{CE}_L and \overline{CE}_R are internal signals. To select either the left or right port, both \overline{CE}_0 and CE_1 must be asserted to their active states ($\overline{CE}_0 \le V_{IL}$ and $CE_1 \ge V_{IH}$).

16. Tested initially and after any design or process changes that may affect these parameters.



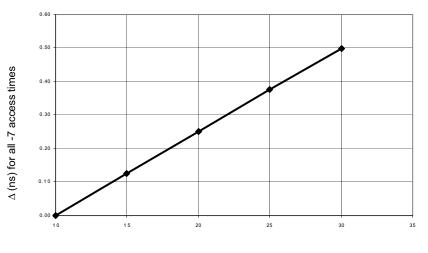
AC Test Loads and Waveforms

Figure 3. AC Test Loads and Waveforms









Capacitance (pF)

(b) Load Derating Curve



Switching Characteristics

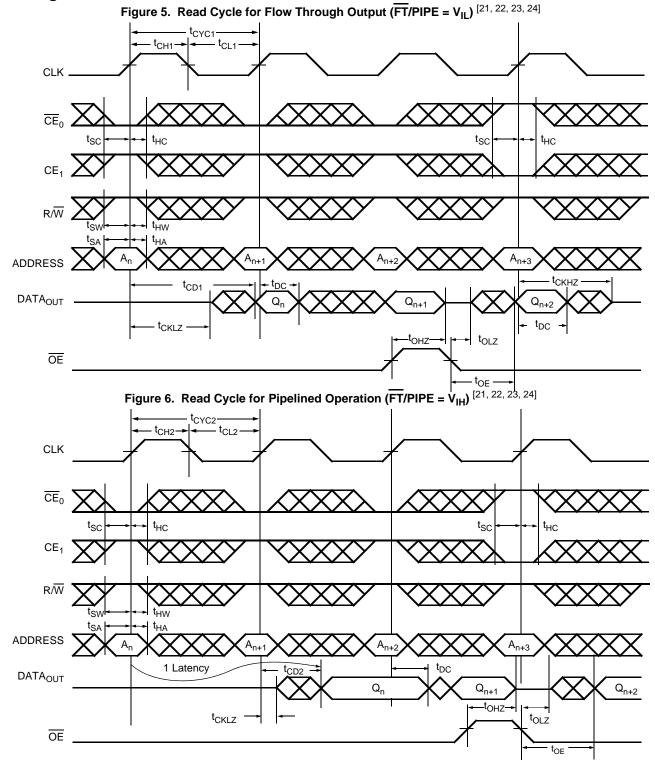
Over the Operating Range

Parameter	Description	CY7C09269V/79V/89V CY7C09369V/89V -7 ^[18] -9 -12						
Parameter	Description				9		12	Unit
		Min	Max	Min	Max	Min	Max	
f _{MAX1}	f _{Max} Flow Through	-	45	-	40	-	33	MHz
f _{MAX2}	f _{Max} Pipelined	-	83	-	67	-	50	MHz
t _{CYC1}	Clock Cycle Time - Flow Through	22	-	25	-	30	-	ns
t _{CYC2}	Clock Cycle Time - Pipelined	12	-	15	-	20	-	ns
t _{CH1}	Clock HIGH Time - Flow Through	7.5	-	12	-	12	-	ns
t _{CL1}	Clock LOW Time - Flow Through	7.5	-	12	-	12	-	ns
t _{CH2}	Clock HIGH Time - Pipelined	5	-	6	-	8	-	ns
t _{CL2}	Clock LOW Time - Pipelined	5	-	6	-	8	_	ns
t _R	Clock Rise Time	-	3	-	3	-	3	ns
t _F	Clock Fall Time	-	3	-	3	-	3	ns
t _{SA}	Address Set-Up Time	4	-	4	-	4	-	ns
t _{HA}	Address Hold Time	0	-	1	-	1	-	ns
t _{SC}	Chip Enable Setup Time	4	-	4	-	4	-	ns
t _{HC}	Chip Enable Hold Time	0	-	1	-	1	_	ns
t _{SW}	R/W Set-Up Time	4	-	4	-	4	_	ns
t _{HW}	R/W Hold Time	0	-	1	-	1	-	ns
t _{SD}	Input Data Setup Time	4	-	4	-	4	-	ns
t _{HD}	Input Data Hold Time	0	-	1	-	1	-	ns
t _{SAD}	ADS Set-Up Time	4	-	4	-	4	-	ns
t _{HAD}	ADS Hold Time	0	-	1	-	1	_	ns
t _{SCN}	CNTEN Setup Time	4.5	-	5	-	5	_	ns
t _{HCN}	CNTEN Hold Time	0	-	1	-	1	_	ns
t _{SRST}	CNTRST Setup Time	4	-	4	-	4	_	ns
t _{HRST}	CNTRST Hold Time	0	-	1	-	1	_	ns
t _{OE}	Output Enable to Data Valid	-	9	_	10	_	12	ns
t _{OLZ} ^[19, 20]	OE to Low Z	2	_	2	_	2	_	ns
t _{OHZ} ^[19, 20]	OE to High Z	1	7	1	7	1	7	ns
t _{CD1}	Clock to Data Valid - Flow Through	-	18	-	20	_	25	ns
t _{CD2}	Clock to Data Valid - Pipelined	_	7.5	_	9	_	12	ns
t _{DC}	Data Output Hold After Clock HIGH	2	_	2	_	2	_	ns
t _{СКНZ} ^[19, 20]	Clock HIGH to Output High Z	2	9	2	9	2	9	ns
t _{CKLZ} ^[19, 20]	Clock HIGH to Output Low Z	2	-	2	-	2	_	ns
Port to Port	Delays	1	I	I	I	1	1	1
t _{CWDD}	Write Port Clock HIGH to Read Data Delay	-	35	-	40	-	40	ns
t _{CCS}	Clock to Clock Setup Time	-	10	-	15	_	15	ns

Notes18. See Figure 4 on page 8 for Load Conditions.19. Test conditions used are Load 2.20. This parameter is guaranteed by design, but it is not production tested.



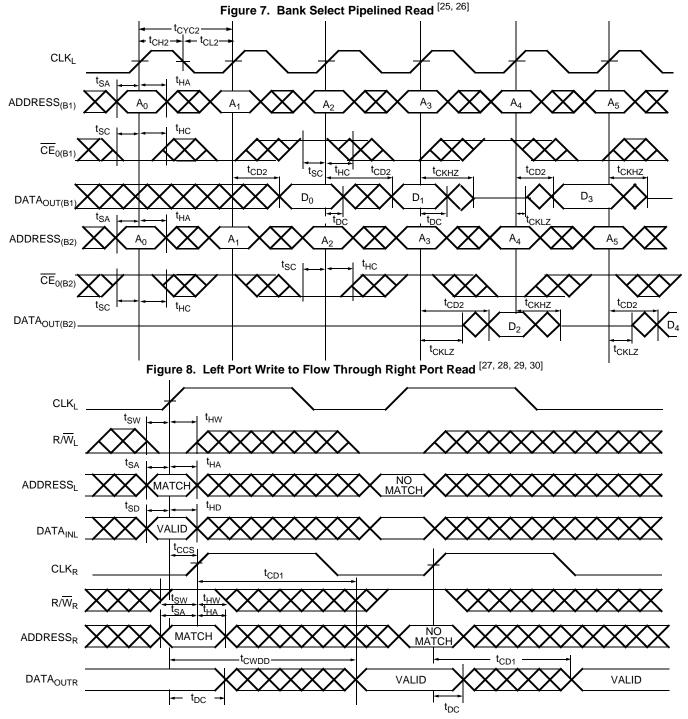
Switching Waveforms



Notes

Notes 21. \overrightarrow{DE} is asynchronously controlled; all other inputs are synchronous to the rising clock edge. 22. $\overrightarrow{ADS} = V_{IL}$, \overrightarrow{CNTEN} and $\overrightarrow{CNTRST} = V_{IH}$. 23. The output is disabled (high impedance state) by $\overrightarrow{CE}_0 = V_{IH}$ or $\overrightarrow{CE}_1 = V_{IL}$ following the next rising edge of the clock. 24. Addresses do not have to be accessed sequentially since $\overrightarrow{ADS} = V_{IL}$ constantly loads the address on the rising edge of the CLK. Numbers are for reference only.





Notes

Notes 25. In this depth expansion example, B1 represents Bank #1 and B2 is Bank #2; Each Bank consists of one Cypress dual-port device from this datasheet. <u>ADDRESS_(B1) = ADDRESS_(B2).</u> 26. UB, LB, OE and ADS = V_{IL}; CE_{1(B1)}, CE_{1(B2)}, RW, CNTEN, and CNTRST = V_{IH}. 27. The same waveforms apply for a right port write to flow through left port read. 28. <u>CE₀</u>, UB, LB, and ADS = V_{IL}; CE₁, CNTEN, and CNTRST = V_{IH}. 29. OE = V_{IL} for the Right Port, which is being read from. OE = V_{IH} for the Left Port, which is being written to. 30. It toos < maximum specified then data from right port PAD is not valid until the maximum specified for toward.

30. It $t_{CCS} \le maximum$ specified, then data from right port READ is not valid until the maximum specified for t_{CWDD} . If t_{CCS} -maximum specified, then data is not valid until $t_{CCS} \le t_{CD1}$. t_{CWDD} does not apply in this case.



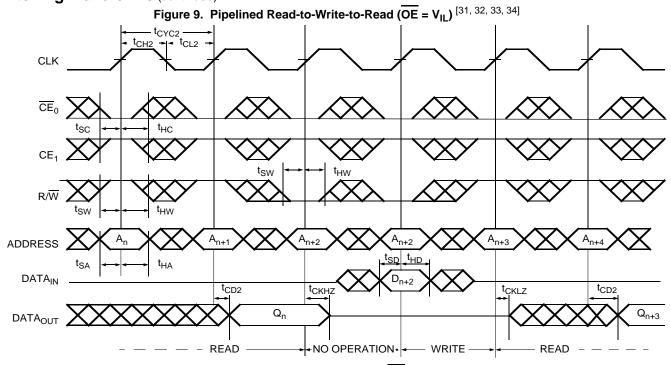
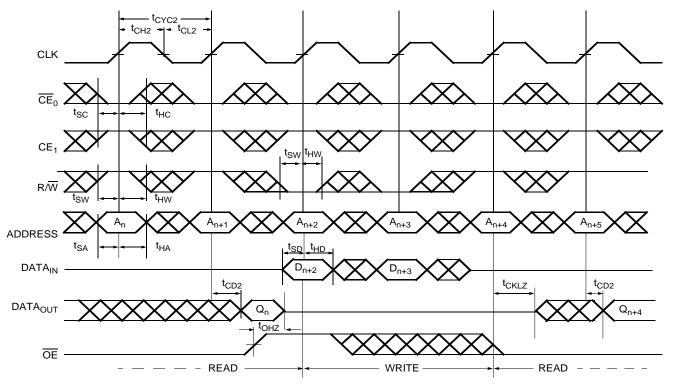


Figure 10. Pipelined Read-to-Write-to-Read (OE Controlled) ^[31, 32, 33, 34]



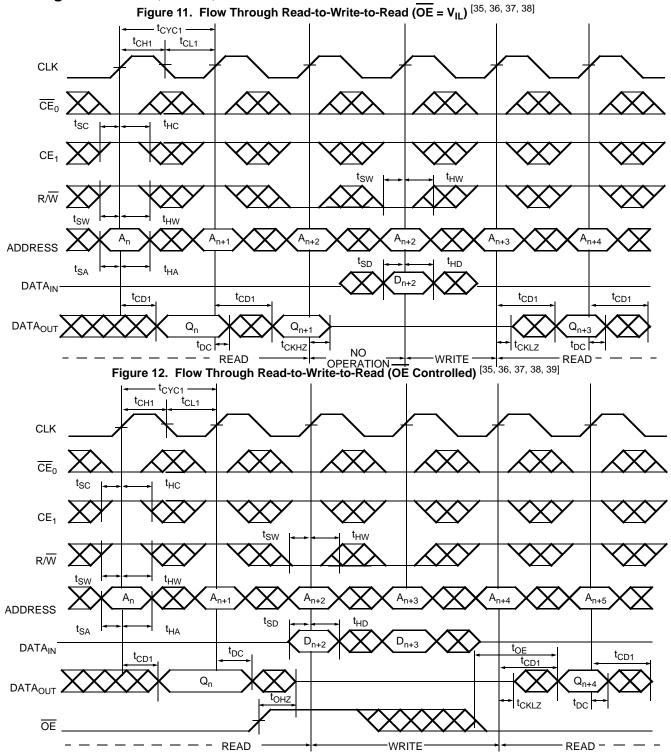
Notes

31. Addresses do not have to be accessed sequentially since $\overline{ADS} = V_{IL}$ constantly loads the address on the rising edge of the CLK. Numbers are for reference only. 32. <u>Output state (High, LOW, or high impedance) is determined by the previous cycle control signals.</u>

33. \overline{CE}_0 and $\overline{ADS} = V_{IL}$; CE_1 , \overline{CNTEN} , and $\overline{CNTRST} = V_{IH}$.

34. During "No Operation", data in memory at the selected address may be corrupted and must be rewritten to ensure data integrity.





Notes

35. $\overline{\text{ADS}} = V_{\text{IL}}$, $\overline{\text{CNTEN}}$ and $\overline{\text{CNTRST}} = V_{\text{IH}}$.

36. Addresses do not have to be accessed sequentially since $\overline{ADS} = V_{IL}$ constantly loads the address on the rising edge of the CLK. Numbers are for reference only. 37. \overline{CE}_0 and $\overline{ADS} = V_{IL}$; \overline{CE}_1 , \overline{CNTEN} , and $\overline{CNTRST} = V_{IH}$.

38. During "No Operation", data in memory at the selected address may be corrupted and must be rewritten to ensure data integrity.

39. Output state (High, LOW, or high impedance) is determined by the previous cycle control signals.



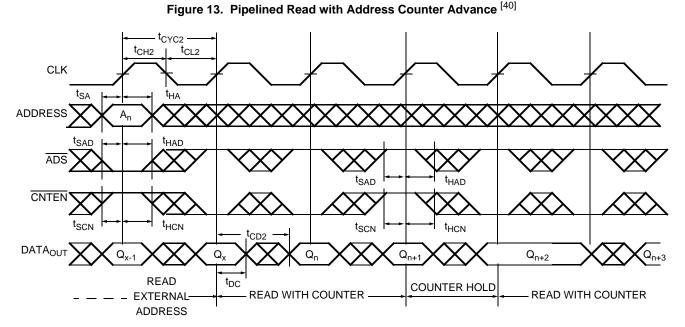
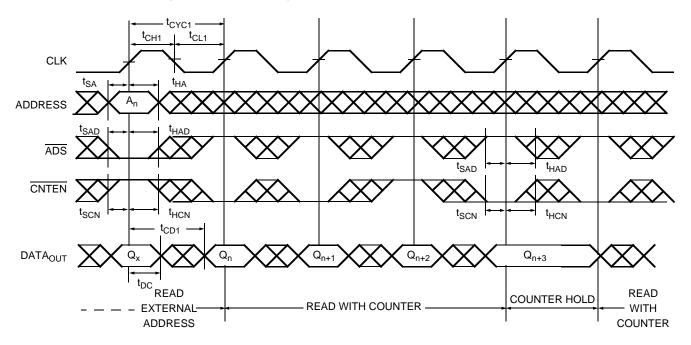


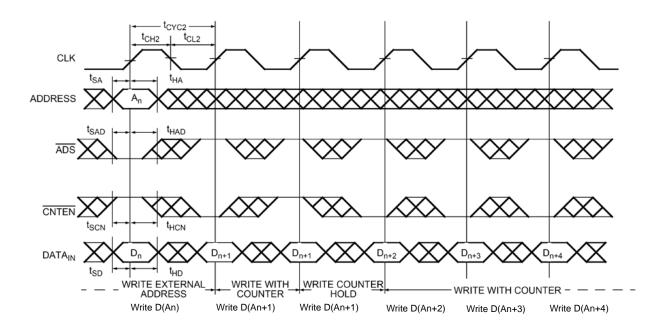
Figure 14. Flow Through Read with Address Counter Advance ^[40]



Note 40. \overline{CE}_0 and $\overline{OE} = V_{IL}$; CE_1 , R/W and $\overline{CNTRST} = V_{IH}$.



Figure 15. Write with Address Counter Advance (Flow Through or Pipelined Outputs) ^[41, 42]



Notes 41. \overline{CE}_0 , \overline{UB} , \overline{LB} , and $\overline{R/W} = V_{IL}$; \overline{CE}_1 and $\overline{CNTRST} = V_{IH}$. 42. The "Internal Address" is equal to the "External Address" when $\overline{ADS} = V_{IL}$ and equals the counter output when $\overline{ADS} = V_{IH}$.



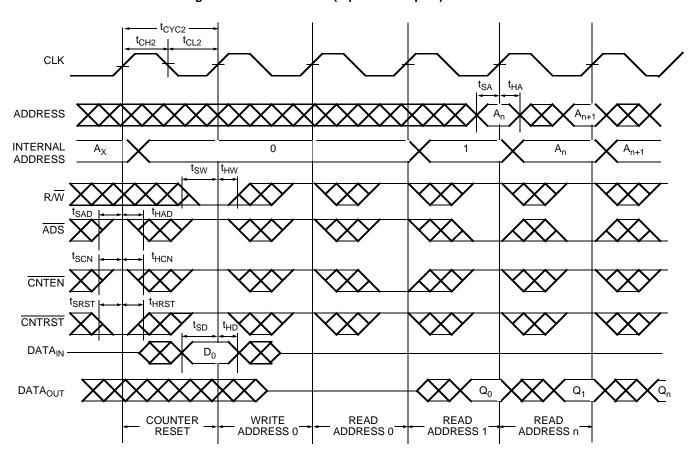


Figure 16. Counter Reset (Pipelined Outputs) [43, 44, 45, 46]

Notes

43. Addresses do not have to be accessed sequentially since ADS = V_{IL} constantly loads the address on the rising edge of the CLK. Numbers are for reference only.

44. <u>Output state (High, LOW, or high impedance)</u> is determined by the previous cycle control signals. 45. \overline{CE}_0 , \overline{UB} , and $\overline{LB} = V_{IL}$; $\overline{CE}_1 = V_{IH}$.

^{46.} No dead cycle exists during counter reset. A READ or WRITE cycle may be coincidental with the counter reset.



Read/Write and Enable Operation

The Read/Write and Enable Operation is described as follows. ^[47, 48, 49]

		Inputs			Outputs	Operation
OE	CLK		CE ₁	R/W	I/O ₀ I/O ₁₇	Operation
Х		Н	Х	Х	High Z	Deselected ^[50]
Х		Х	L	Х	High Z	Deselected ^[50]
Х		L	Н	L	D _{IN}	Write
L		L	Н	Н	D _{OUT}	Read ^[51]
Н	Х	L	Н	Х	High Z	Outputs Disabled

Address Counter Control Operation

The Address Counter Control Operation is described as follows. ^[47, 52, 53, 54]

Address	Previous Address	CLK	ADS	CNTEN	CNTRST	I/O	Mode	Operation
х	х		Х	Х	L	D _{out(0)}	Reset	Counter Reset to Address 0
A _n	Х		L	Х	Н	D _{out(n)}	Load	Address Load into Counter
Х	A _n	4	H	Н	H	D _{out(n)}	Hold	External Address Blocked — Counter Disabled
Х	A _n	5	H	L	H	D _{out(n+1)}	Increment	Counter Enabled — Internal Address Generation

- 49. $\overline{\text{OE}}$ is an asynchronous input signal. 50. When $\overline{\text{CE}}$ changes state in the pipelined mode, deselection and read happen in the following clock cycle. 51. $\overline{\text{ADS}} = V_{|L|}$, $\overline{\text{CNTEN}}$ and $\overline{\text{CNTRST}} = V_{|H|}$. 52. $\overline{\text{CE}}_0$ and $\overline{\text{OE}} = V_{|L|}$; $\overline{\text{CE}}_1$ and $\overline{\text{RW}} = V_{|H|}$.

- 53. Data shown for flow through mode; pipelined mode output is delayed by one cycle. 54. Counter operation is independent of \overline{CE}_0 and \overline{CE}_1 .



Ordering Information

16 K × 16 3.3 V Synchronous Dual-Port SRAM

Speed (ns)	Ordering Code	Package Diagram	Package Type	Operating Range
7.5 ^[55]	CY7C09269V-7AXC	51-85048	100-pin TQFP (Pb-free)	Commercial
9	CY7C09269V-9AXC	51-85048	100-pin TQFP (Pb-free)	Commercial
12	CY7C09269V-12AXC	51-85048	100-pin TQFP (Pb-free)	Commercial

32 K × 16 3.3 V Synchronous Dual-Port SRAM

Speed (ns)	Ordering Code	Package Diagram	Package Type	Operating Range
7.5 ^[55]	CY7C09279V-7AXC	51-85048	100-pin TQFP (Pb-free)	Commercial
12	CY7C09279V-12AXC	51-85048	100-pin TQFP (Pb-free)	Commercial

64 K × 16 3.3 V Synchronous Dual-Port SRAM

Speed (ns)	Ordering Code	Package Diagram	Package Type	Operating Range
9	CY7C09289V-9AXC	51-85048	100-pin TQFP (Pb-free)	Commercial
	CY7C09289V-9AXI	51-85048	100-pin TQFP (Pb-free)	Industrial
12	CY7C09289V-12AXC	51-85048	100-pin TQFP (Pb-free)	Commercial

16 K × 18 3.3 V Synchronous Dual-Port SRAM

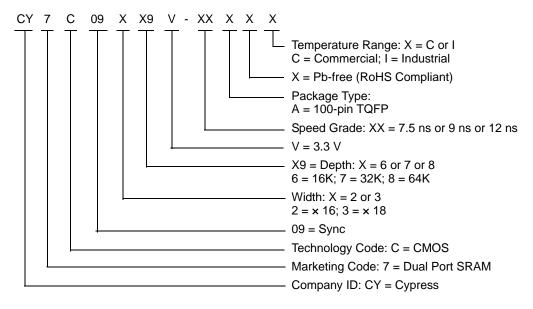
Speed (ns)	Ordering Code	Package Diagram	Package Type	Operating Range
9	CY7C09369V-9AXC	51-85048	100-pin TQFP (Pb-free)	Commercial
12	CY7C09369V-12AXC	51-85048	100-pin TQFP (Pb-free)	Commercial

64 K × 18 3.3 V Synchronous Dual-Port SRAM

Speed (ns)	Ordering Code Package Diagram		Package Type	Operating Range
7.5 ^[55]	CY7C09389V-7AXC	51-85048	100-pin TQFP (Pb-free)	Commercial
9	CY7C09389V-9AI	51-85048	100-pin TQFP	Industrial

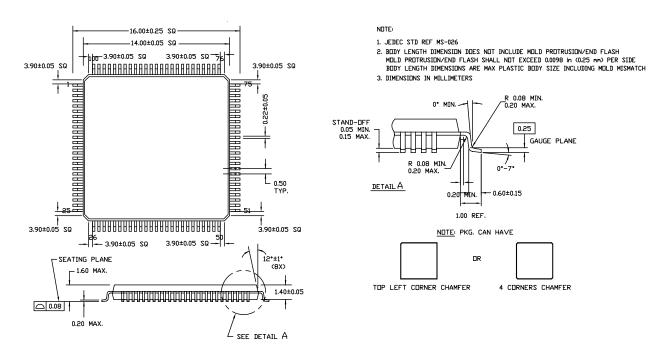


Ordering Code Definitions



Package Diagrams





51-85048 *G



Acronyms

Acronym	Description
CE	chip enable
CMOS	complementary metal oxide semiconductor
I/O	input/output
OE	output enable
SRAM	static random access memory
TQFP	thin quad flat pack
TTL	transistor-transistor logic

Document Conventions

Units of Measure

Symbol	Unit of Measure
C	degree Celsius
MHz	megahertz
μA	microampere
mA	milliampere
mm	millimeter
mV	millivolt
ns	nanosecond
Ω	ohm
%	percent
pF	picofarad
V	volt



Document History Page

Revision	ECN	Submission Date	Orig. of Change	Description of Change
**	110215	12/18/01	SZV	Change from Spec number: 38-00668 to 38-06056
*A	122306	12/27/02	RBI	Power up requirements added to Maximum Ratings Information
*B	344354	See ECN	PCX	Added Pb-Free Part Ordering Information
*C	2678221	03/25/2009	VKN / AESA	Added CY7C09379V-12AXCT part. Updated 51-85048 to *C.
*D	2896210	03/22/2010	RAME	Updated Ordering Information. Updated Package Diagrams.
*E	3111417	12/15/2010	ADMU	Updated Ordering Information. Added Ordering Code Definitions.
*F	3124048	12/30/2010	ADMU	No technical updates.
*G	3352110	08/23/2011	ADMU	Updated Features (Removed CY7C09379V information and also removed -6 speed bin information). Updated Pin Configurations (Removed CY7C09379V information). Updated Selection Guide (Removed CY7C09379V information and also removed -6 speed bin information). Updated Functional Description (Removed CY7C09379V information). Updated Electrical Characteristics (Removed CY7C09379V information). Updated Electrical Characteristics (Removed CY7C09379V information and also removed -6 speed bin information). Updated AC Test Loads and Waveforms (Removed -6 speed bin information) Updated Switching Characteristics (Removed CY7C09379V information and also removed -6 speed bin information). Updated Ordering Information (Removed part CY7C09279V-7AC). Updated Package Diagrams. Added Acronyms and Units of Measure. Updated in new template.
*H	3402091	10/12/2011	ADMU	Updated Ordering Information (Removed pruned part CY7C09289V-9AI). Updated Package Diagrams.
*	3680923	08/01/2012	ADMU / SMCH	Updated Pin Configurations (Updated Figure 2). Updated Switching Characteristics (Changed name of parameter from t_{CKZ} to t_{CKHZ} , changed name of parameter from t_{CKZ} to t_{CKLZ} in the next corresponding row). Updated Switching Waveforms (Updated Figure 15). Updated Address Counter Control Operation. Updated Ordering Information (Removed pruned part CY7C09289V-9AC). Updated Package Diagrams (spec 51-85048 (Changed revision from *E to *G)).



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